



5.78 6.4 5.252 5.25

mm inch



FEATURES

1-Channel (Form B)

4-pin Type

1. Low on resistance for normallyclosed type

GU (General Use)-E Type

This has been realized thanks to the builtin MOSFET processed by our proprietary method, DSD (Double-diffused and Selective Doping) method.

Cross section of the normally-closed type of power MOS



2. Reinforced insulation 5,000 V type More than 0.4 mm internal insulation distance between inputs and outputs. Conforms to EN41003, EN60950 (reinforced insulation).

3. Compact 4-pin DIP size

RELAYS

The device comes in a compact (W)6.4×(L)4.78×(H)3.2mm (W).252×(L).188×(H).126inch, 4-pin DIP size

PhotoMOS

4. Controls low-level analog signals PhotoMOS relays feature extremely low closed-circuit offset voltage to enable control of low-level analog signals without distortion.

5. High sensitivity, low ON resistance

Can control a maximum 0.13 A load current with a 5 mA input current. Low ON resistance of 18Ω (AQY410EH). Stable operation because there are no metallic contact parts.

6. Low-level off state leakage current

TYPICAL APPLICATIONS

- Modem
- Telephone equipment
- Security equipment
- Sensors

TYPES

Туре	I/O isolation voltage	Output rating*		Part No.					
				Through hole terminal	Surface-mount terminal			Packing quantity	
		Load Load voltage	Lood			Tape and reel	packing style		Topo and
			Tube packing style		Picked from the 1/2-pin side	Picked from the 3/4-pin side	Tube	reel	
AC/DC type	Reinforced 5,000 V	350 V	130 mA	AQY410EH	AQY410EHA	AQY410EHAX	AQY410EHAZ	1 tube contains 100 pcs. 1 batch contains 1,000 pcs.	1,000 pcs.
		400 V	120 mA	AQY414EH	AQY414EHA	AQY414EHAX	AQY414EHAZ		

*Indicate the peak AC and DC values.

Note: For space reasons, the initial letters of the product number "AQY", the SMD terminal shape indicator "A" and the package type indicator "X" and "Z" are omitted from the seal.

RATING

1	Absolute maximum	ratings	(Amhient tem	perature: 25°C	77°F)
		raunys		$perature. z_{J} \cup 1$	<i>I I I I</i>

Item			Symbol	AQY410EH (A)	AQY414EH (A)	Remarks
Input	LED forward current		lf	50 r		
	LED reverse voltage		Vr	3		
	Peak forward current		IFP	1.	f = 100 Hz, Duty factor = 0.1%	
	Power dissipation		Pin	75 r		
	Load volta	Load voltage (peak AC)		350 V	400 V	
Output	Continuous load current		١L	0.13 A	0.12 A	
Output	Peak load current		Ipeak	0.4 A	0.3 A	100 ms (1 shot), V∟= DC
	Power dissipation		Pout	500 mW		
Total power dissipation			Рт	550		
I/O isolation voltage			Viso	5,000		
Tempe	erature C	ature Operating		−40°C to +85°C −40°F to +185°F		Non-condensing at low temperatures
lin	nits S	Storage	Tstg	–40°C to +100°C		



AQY41OEH

2. Electrical ch	naracteristics (A	mbient temp	perature: 2	25°C 77°F)			
	Item		Symbol	AQY410EH (A)	AQY414EH (A)	Condition	
	LED operate	Typical		1.4 mA	1.3 mA	L Mox	
	(OFF) current	Maximum	IFott	3.0	IL=IVIAX.		
laaut	LED reverse (ON) current	Minimum	- IFon	0.4	L-Mox		
input		Typical		1.3 mA	1.2 mA	IL=IVIAX.	
	LED dropout	Typical	V-	1.14 (1.25 V a			
	voltage	Maximum		1.5 V			
	On resistance	Typical	D	18Ω	26Ω	IF = 0 mA	
Output		Maximum	Kon	25Ω	35Ω	Within 1 s on time	
	Off state leak- age current	Maximum	Leak	10μΑ		I⊧ = 5 mA V∟ = Max.	
	Operate (OFF)	Typical	т	1.0 ms	0.8 ms	I⊧ = 0 mA>5 mA	
	time*	Maximum	loff	3.0	I∟ = Max.		
	r- time*	Typical	т	0.3 ms	0.2 ms	I⊧ = 5 mA>0 mA	
Transfer char-		Maximum	Ion	1.0	I∟ = Max.		
acteristics	1/0	Typical	0	0.8	f =1MHz V _B =0		
	1/O capacitance	Maximum	Ciso	1.5			
	Initial I/O isola- tion resistance	Minimum	Riso	1,000ΜΩ		500 V DC	

Note: Recommendable LED forward current I_F = 5 to 10mA.

For type of connection, see page 32.

*Operate/Reverse time



■ For Dimensions, see Page 27.

■ For Schematic and Wiring Diagrams, see Page 32.

■ For Cautions for Use, see Page 36.

REFERENCE DATA

1. Load current vs. ambient temperature characteristics

Allowable ambient temperature: -40°C to +85°C -40°F to +185°F



2. On resistance vs. ambient temperature characteristics

Measured portion: between terminals 3 and 4; LED current: 0 mA; Load voltage: Max.(DC); Continuous load current: Max. (DC)



3. Operate (OFF) time vs. ambient temperature characteristics

LED current: 5 mA; Load voltage: Max. (DC); Continuous load current: Max. (DC)



AQY41OEH

4. Reverse (ON) time vs. ambient temperature characteristics

LED current: 5 mA; Load voltage: Max. (DC); Continuous load current: Max. (DC)



7. LED dropout voltage vs. ambient temperature characteristics

LED current: 5 to 50 mA



10. LED forward current vs. Operate (OFF) time characteristics

Measured portion: between terminals 3 and 4; Load voltage: Max. (DC); Continuous load current: Max. (DC); Ambient temperature: $25^{\circ}C$ $77^{\circ}F$



5. LED operate (OFF) current vs. ambient temperature characteristics

Load voltage: Max. (DC); Continuous load current: Max. (DC)



8. Voltage vs. current characteristics of out-put at MOS portion

Measured portion: between terminals 3 and 4; Ambient temperature: 25°C 77°F



6. LED reverse (ON) current vs. ambient temperature characteristics Load voltage: Max. (DC);

Continuous load current: Max. (DC)



9. Off state leakage current Measured portion: between terminals 3 and 4; Ambient temperature: 25°C 77°F



12. Applied voltage vs. output capacitance characteristics

Measured portion: between terminals 3 and 4; Frequency: 1 MHz; Ambient temperature: $25^{\circ}C$ $77^{\circ}F$



11. LED forward current vs. Reverse (ON) time characteristics

Measured portion: between terminals 3 and 4; Load voltage: Max. (DC); Continuous load current: Max. (DC); Ambient temperature: $25^{\circ}C$ $77^{\circ}F$

